

2024- 2025 MPW schedule

Last updated: September 5, 2024

| MPW name | Fab | Processes | Tape-In | Ship Date |
|--------------------------|---------------|---|----------------------|-----------|
| PH18DA - B5603 | NPB - Fab 3 | SiPho 0.18um | 2-20-24 | 10-25-24 |
| SB*18 - B5604 | NPB - Fab 3 | SiGe BiCMOS 0.18um | 3-05-24 | 9-10-24 |
| PH18M* - B5609 | NPB - Fab 3 | SiPho 0.18um | 5-14-24 | 9-27-24 |
| SB*18 - B5611 | NPB - Fab 3 | SiGe BiCMOS 0.18um | 6-11-24 | 12-19-24 |
| CS18* - B5608 | MH - Fab 2 | CMOS-SOI 0.18um | 6-18-24 | |
| CA18 - B5613 | NPB - Fab 3 | RFCMOS 0.18um | 7-16-24 | 12-27-24 |
| SB*18 - B5615 | NPB - Fab 3 | SiGe BiCMOS 0.18um | 8-13-24 | 2-20-25 |
| PH18DA - B5614 | NPB - Fab 3 | SiPho 0.18um | 8-20-24 | 4-25-25 |
| 30th MPW - Tonami, Japan | TPSCo - Fab 5 | CMOS 0.18u & 0.16u, PM, PM_SOI | 8-26-24 | |
| PH18M* - B5617 | NPB - Fab 3 | SiPho 0.18um | 9-10-24 | 1-24-25 |
| 32nd MPW - Uozu, Japan | TPSCo - Fab 7 | CMOS,PM & RFCMOS, 65nm : TPS65SLA/SLC, TPS65PMA/PMB/MSA/MSB, TPS65RF | 9-24-24 | |
| SB*18 - B5619 | NPB - Fab 3 | SiGe BiCMOS 0.18um | 10-8-24 | 4-17-25 |
| CS18* - B5616 | MH - Fab 2 | CMOS-SOI 0.18um | 10-22-24 | |
| Q4 2024 | NM – Fab 11 | TPS65MSPM | 10-15-24 | |
| 33rd MPW - Uozu, Japan | TPSCo - Fab 7 | 300mm Silicon Photonics: TPS45PHD | 10-28-24 | |
| CA18 - B5621 | NPB - Fab 3 | RFCMOS 0.18um | 11-5-24 | 4-18-25 |
| SH524T18NOV | MH - Fab 2 | CIS 0.18u Image Sensor CMOS+ 0.16u, 0.18u RF, RFID, PM | 11-14-24 11-21-24 | |
| SB*18 - B5622 | NPB - Fab 3 | SiGe BiCMOS 0.18um | 11-19-24 | 5-29-25 |
| 31st MPW - Tonami, Japan | TPSCo - Fab 5 | CMOS 0.18u & 0.16u, PM, PM_SOI | 11-25-24 | |
| Q1 2025 | NM – Fab 11 | TPS65MSPM | 2-4-25 | |
| SH125T18FEB | MH - Fab 2 | 0.18 BSI, Stacking on 0.13 | 2-12-25 | |
| SH225T18APRIL | MH - Fab 2 | CIS 0.18u Image Sensor CMOS+ 0.16u, 0.18u RF, RFID, PM | 4-10-25 4-17-25 | |
| SH325T18NOV | MH - Fab 2 | CIS 0.18u Image Sensor CMOS+ 0.16u, 0.18u RF, RFID, PM | 11-17-25 11-23-25 | |

Notes: "Shuttles" (SH*) are run at Fab 2

* 0.13u MH – fab 2 Shuttle / MPW slots will be considered per needs

Please contact your customer account manager for additional information.

Fab2 - Tower Semiconductor 200mm wafer fabrication facility at Migdal Ha'emek, Israel

Fab3 - Tower Semiconductor 200mm wafer fabrication facility at Newport Beach, CA

Fab5 - Tower Semiconductor 200mm wafer fabrication facility at Tonami, Japan

Fab7 - Tower Semiconductor 300mm wafer fabrication facility at Uozu, Japan

Fab11 - Tower Semiconductor 300mm wafer fabrication facility at Rio Rancho, NM